imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



GaN on SiC HEMT Pulsed Power Transistor 700 W Peak, 1030 - 1090 MHz, Mode-S ELM

Features

- GaN on SiC Depletion-Mode Transistor Technology
- Internally Matched
- Common-Source Configuration
- Broadband Class AB Operation
- 50 V Operation
- RoHS* Compliant and 260 °C Reflow Compatible
- MTTF = 600 years (T_J < 200 °C)

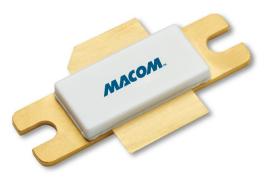
Applications

- Civilian Air Traffic Control (ATC)
- Secondary Radar for IFF and Mode-S Avionics.

Description

The MAGX-001090-700L00 and MAGX-001090-700L0S are gold metalized matched Gallium Nitride (GaN) on Silicon Carbide (SiC) RF power transistor optimized for pulsed avionics and radar applications. Using state of the art wafer fabrication processes, these high performance transistors provide high gain, efficiency, bandwidth, and ruggedness over a wide bandwidth for today's demanding application needs. High breakdown voltages allow for reliable and stable operation under more extreme mismatch load conditions compared with older semiconductor technologies.

MAGX-001090-700L00



MAGX-001090-700L0S



Ordering Information¹

| Part Number | Description |
|--------------------|-----------------------------------|
| MAGX-001090-700L00 | Standard Flange |
| MAGX-001090-700L0S | Earless Flange |
| MAGX-A11090-700L00 | 1030-1090 MHz Evaluation Board |

1. When ordering the evaluation board, please indicate on sales order notes if it will be used for:

- A. Standard Flange devices
- B. Earless Flange devices

Typical RF Performance under Standard Operating Conditions, Pout = 700 W (Peak)

| Freq (MHz) | P _{IN} (W) | Gain (dB) | I _D (A) | Eff. (%) | RL (dB) | Droop (dB) | +1dB OD (W) | VSWR-S (3:1) | VSWR-T (3:1) |
|---------------|------------------------|--------------|-----------------------|-------------|------------|---------------|----------------|-----------------|-----------------|
| 1030 | 6.1 | 20.6 | 20.6 | 68.0 | -13.5 | 0.25 | 766 | S | Р |
| 1060 | 6.0 | 20.7 | 20.4 | 68.5 | -18.4 | 0.25 | 760 | S | Р |
| 1090 | 6.5 | 20.3 | 21.0 | 66.7 | -15.7 | 0.25 | 760 | S | Р |

* Restrictions on Hazardous Substances, European Union Directive 2011/65/EU.

1

M/A-COM Technology Solutions Inc. (MACOM) and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice. Visit www.macom.com for additional data sheets and product information.

МЛСОМ



GaN on SiC HEMT Pulsed Power Transistor 700 W Peak, 1030 - 1090 MHz, Mode-S ELM

Rev. V3

Electrical Specifications: Freq. = 1030 - 1090 MHz, T_A = 25 °C

| Parameter | Test Conditions | Symbol | Min. | Тур. | Max. | Units |
|---------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------|------|------|------|-------|
| Mode-S ELM RF Functional Tests ² | | | | | | |
| Peak Input Power | V _{DD} = 50 V, I _{DQ} = 500 mA, 48 pulses of 32 µs on and 18 µs off, repeat every 24 ms, Overall Duty Factor = 6.4%, P _{OUT} = 700 W Peak (70 W avg.) | P _{IN} | - | 6.3 | 8.5 | W |
| Power Gain | | G _P | 19.2 | 20.5 | - | dB |
| Drain Efficiency | | η _D | 62 | 67 | - | % |
| Pulse Droop | | Droop | - | 0.25 | 0.5 | dB |
| Load Mismatch Stability | | VSWR-S | - | 3:1 | - | - |
| Load Mismatch Tolerance | | VSWR-T | - | 3:1 | - | - |

 For Mode-S ELM pulse conditions power measurements are obtained as follows: RF input / output power is measured at the middle of the 25th pulse in the burst (t = 1.216 ms); Droop measurements are defined as the drop in power from the 5th pulse (t = 216us) and 43rd pulse (t = 2.116ms) in the burst.

Electrical Characteristics: T_A = 25°C

| Parameter | Test Conditions | Symbol | | Тур. | | Units |
|------------------------------|-------------------------------------------------|----------------------|---|------|---|-------|
| DC Characteristics | | | | | | |
| Drain-Source Leakage Current | V_{GS} = -8 V, V_{DS} = 175 V | I _{DS} | - | 1.7 | - | mA |
| Gate Threshold Voltage | V_{DS} = 5 V, I _D = 90 mA | V _{GS (TH)} | - | -3.1 | - | V |
| Forward Transconductance | V_{DS} = 5 V, I _D = 21 mA | G _M | - | 22 | - | S |
| Dynamic Characteristics | | | | | | |
| Input Capacitance | Not applicable - Input matched | C _{ISS} | - | N/A | - | pF |
| Output Capacitance | V _{DS} = 50 V, V _{GS} = -8 V, | C _{oss} | - | 55 | - | pF |
| Reverse Transfer Capacitance | Freq. = 1 MHz | C _{RSS} | - | 5.5 | - | pF |

M/A-COM Technology Solutions Inc. (MACOM) and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice. Visit <u>www.macom.com</u> for additional data sheets and product information.



Absolute Maximum Ratings^{3,4,5}

| Parameter | Rating |
|---------------------------------------------|----------------------------------|
| Drain Voltage (V _{DD}) | +65 V |
| Gate Voltage (V _{GG}) | -8 to -2 V |
| Drain Current (I _{DD}) | 31 A |
| Input Power ⁶ (P _{IN}) | P _{IN} (nominal) + 3 dB |
| Operating Junction Temperature ⁷ | 250 °C |
| Peak Pulsed Power Dissipation at 85 °C | 875 W |
| Operating Temperature Range | -40 to +95 °C |
| Storage Temperature Range | -65 to +150 °C |
| ESD Maximum - Charged Device Model (CDM) | 1300 V |
| ESD Maximum - Human Body Model (HBM) | 4000 V |

3. Exceeding any one or combination of these limits may cause permanent damage to this device.

4. MACOM does not recommend sustained operation near these survivability limits.

5. For saturated performance it is recommended that the sum of ($3 * V_{DD} + |V_{GG}|$) < 175 V.

6. Input Power Limit is +3 dB over nominal drive required to achieve $P_{OUT} = 700 \text{ W}$.

7. Operating junction temperature is measured with infrared (IR) microscope. Junction temperature directly affects a device's MTTF and should be kept as low as possible to maximize lifetime.

- MTTF = 5.3×10^6 hours (T_J < 200 °C)
- MTTF = 6.8×10^4 hours (T_J < 250 °C)

Thermal Characteristics

| Parameter | Test Conditions | Symbol | Typical | Units |
|--------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------|---------|-------|
| Thermal Resistance | $T_{C} = 70 \text{ °C}, V_{DD} = 50 \text{ V}, I_{DQ} = 500 \text{ mA}, P_{OUT} = 700 \text{ W},$ 48 pulses of 32 µs on and 18 µs off, repeat every 24 ms, Overall Duty Factor = 6.4%, | Θ _{JC} | 0.2 | °C/W |

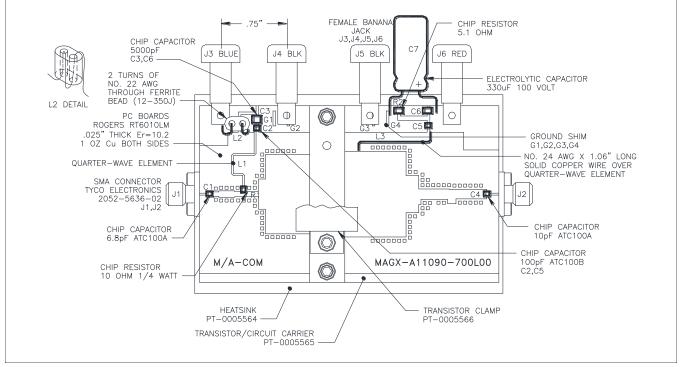
масом



GaN on SiC HEMT Pulsed Power Transistor 700 W Peak, 1030 - 1090 MHz, Mode-S ELM

Rev. V3

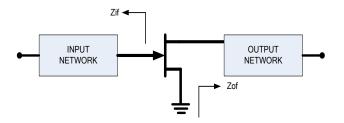
Test Fixture Assembly



Contact MACOM for additional circuit information.

Test Fixture Impedances

| Freq. (MHz) | Z _{IF} (Ω) | Z _{OF} (Ω) |
|-------------|---------------------|---------------------|
| 1030 | 0.7 - j0.4 | 1.3 + j0.8 |
| 1060 | 0.8 - j0.3 | 1.4 + j0.7 |
| 1090 | 0.8 - j0.1 | 1.4 + j0.7 |



Correct Device Sequencing

Turning the device ON

- 1. Set V_{GS} to the pinch-off (V_P), typically -5 V.
- 2. Turn on V_{DS} to nominal voltage (50 V).
- 3. Increase V_{GS} until the I_{DS} current is reached.
- 4. Apply RF power to desired level.

Turning the device OFF

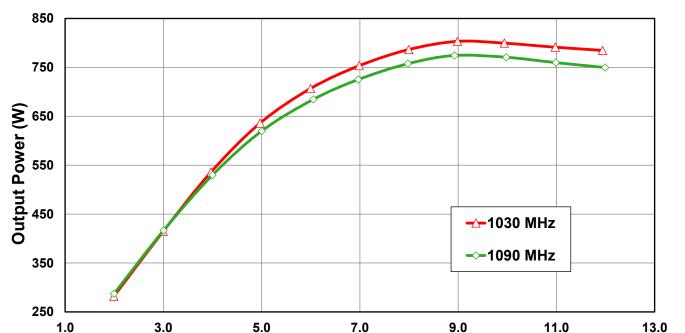
- 1. Turn the RF power off.
- 2. Decrease V_{GS} down to V_{P}
- 3. Decrease V_{DS} down to 0 V.
- 4. Turn off V_{GS}

Contact factory for gerber file or additional circuit information.

4

M/A-COM Technology Solutions Inc. (MACOM) and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice. Visit www.macom.com for additional data sheets and product information.

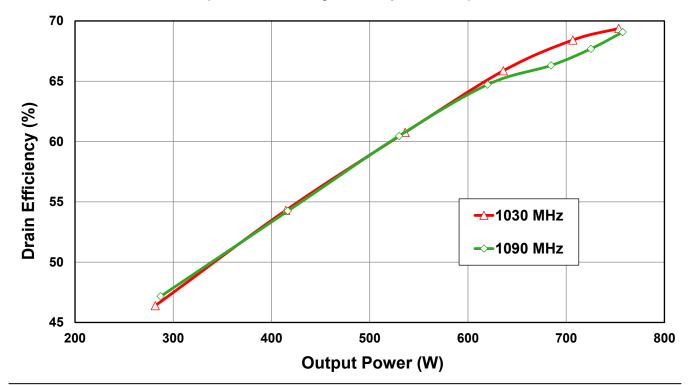
GaN on SiC HEMT Pulsed Power Transistor 700 W Peak, 1030 - 1090 MHz, Mode-S ELM



RF Power Transfer Curve (Output Power vs. Input Power)

Input Power (W)

RF Power Transfer Curve (Drain Efficiency vs. Output Power)

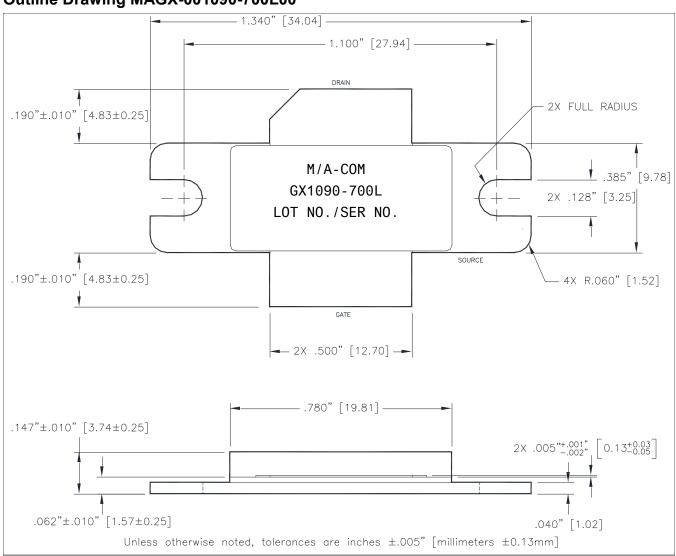


МАСОМ

M/A-COM Technology Solutions Inc. (MACOM) and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice. Visit <u>www.macom.com</u> for additional data sheets and product information.

GaN on SiC HEMT Pulsed Power Transistor 700 W Peak, 1030 - 1090 MHz, Mode-S ELM

Outline Drawing MAGX-001090-700L00[†]

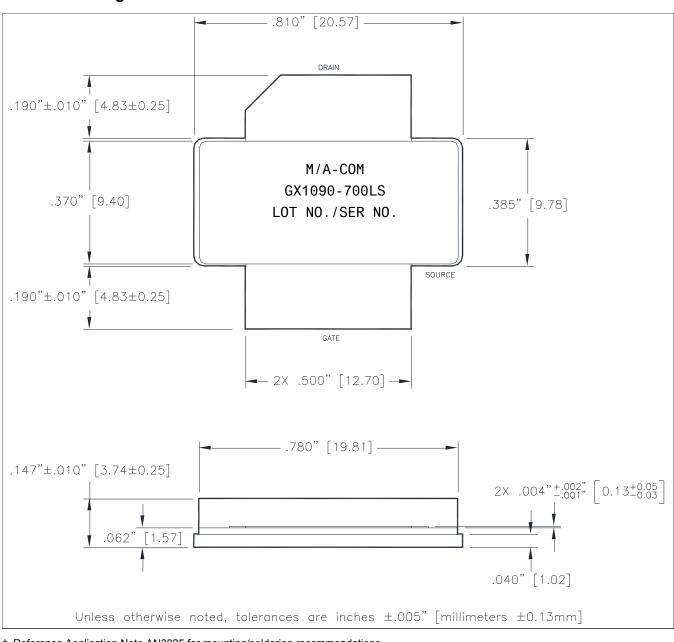


† Reference Application Note AN3025 for mounting/soldering recommendations. Meets JEDEC moisture sensitivity level 1 requirements. Plating is Ni/Au.

6

GaN on SiC HEMT Pulsed Power Transistor 700 W Peak, 1030 - 1090 MHz, Mode-S ELM

Outline Drawing MAGX-001090-700L0S[†]



† Reference Application Note AN3025 for mounting/soldering recommendations. Meets JEDEC moisture sensitivity level 1 requirements. Plating is Ni/Au. MACOM

⁷

M/A-COM Technology Solutions Inc. (MACOM) and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice. Visit www.macom.com for additional data sheets and product information.

GaN on SiC HEMT Pulsed Power Transistor 700 W Peak, 1030 - 1090 MHz, Mode-S ELM



Rev. V3

M/A-COM Technology Solutions Inc. All rights reserved.

Information in this document is provided in connection with M/A-COM Technology Solutions Inc ("MACOM") products. These materials are provided by MACOM as a service to its customers and may be used for informational purposes only. Except as provided in MACOM's Terms and Conditions of Sale for such products or in any separate agreement related to this document, MACOM assumes no liability whatsoever. MACOM assumes no responsibility for errors or omissions in these materials. MACOM may make changes to specifications and product descriptions at any time, without notice. MACOM makes no commitment to update the information and shall have no responsibility whatsoever for conflicts or incompatibilities arising from future changes to its specifications and product descriptions. No license, express or implied, by estoppels or otherwise, to any intellectual property rights is granted by this document.

THESE MATERIALS ARE PROVIDED "AS IS" WITHOUT WARRANTY OF ANY KIND, EITHER EXPRESS OR IMPLIED, RELATING TO SALE AND/OR USE OF MACOM PRODUCTS INCLUDING LIABILITY OR WARRANTIES RELATING TO FITNESS FOR A PARTICULAR PURPOSE, CONSEQUENTIAL OR INCIDENTAL DAMAGES, MERCHANTABILITY, OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT. MACOM FURTHER DOES NOT WARRANT THE ACCURACY OR COMPLETENESS OF THE INFORMATION, TEXT, GRAPHICS OR OTHER ITEMS CONTAINED WITHIN THESE MATERIALS. MACOM SHALL NOT BE LIABLE FOR ANY SPECIAL, INDIRECT, INCIDENTAL, OR CONSEQUENTIAL DAMAGES, INCLUDING WITHOUT LIMITATION, LOST REVENUES OR LOST PROFITS, WHICH MAY RESULT FROM THE USE OF THESE MATERIALS.

MACOM products are not intended for use in medical, lifesaving or life sustaining applications. MACOM customers using or selling MACOM products for use in such applications do so at their own risk and agree to fully indemnify MACOM for any damages resulting from such improper use or sale.

⁸

M/A-COM Technology Solutions Inc. (MACOM) and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice. Visit www.macom.com for additional data sheets and product information.